

20V PNP HIGH GAIN TRANSISTOR PowerDI[®]5

Features

- 43% smaller than SOT223; 60% smaller than TO252
- Maximum height just 1.1mm
- Rated up to 1.3W
- V_{CEO} = -20V
- $I_C = -8A$; $I_{CM} = -15A$
- Low Saturation voltage, high gain transistor
- Lead, Halogen and Antimony Free, RoHS Compliant (Note 1)
- "Green" Device (Note 2)

Applications

- · Load disconnect switch
- · Battery charging

Mechanical Data

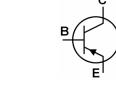
- Case: PowerDI[®]5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Copper leadframe.
 Solderable per MIL-STD-202, Method 208 [®]
- Weight: 0.093 grams (approximate)

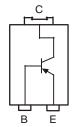


Top View



Bottom View





Device Schematic

Pin-out diagram

Ordering Information (Note 3)

| ſ | Part Number | Case | Packaging |
|---|-----------------|------------------------|------------------|
| | DXTP19020DP5-13 | PowerDI [®] 5 | 5000/Tape & Reel |

Notes:

- 1. No purposefully added lead. Halogen and Antimony Free.
- Diodes Inc's "Green" Policy can be found on our website at http://www.diodes.com
 For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



DTP1920D = Product Type Marking Code
DII = Manufacturers' Code Marking
K = Factory Designator
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 09 for 2009)
WW = Week code (01 to 53)



Maximum Ratings @T_A = 25°C unless otherwise specified

| Characteristic | Symbol | Value | Unit |
|--|------------------|-------|------|
| Collector-Base Voltage | V_{CBO} | -25 | V |
| Collector-Emitter Voltage | V _{CEO} | -20 | V |
| Emitter-Collector Voltage (Reverse Blocking) | V _{ECO} | -4 | V |
| Emitter-Base Voltage | V _{EBO} | -7 | V |
| Continuous Collector Current | Ic | -8 | A |
| Base Current | I _B | -1 | A |
| Peak Pulse Current | I _{CM} | -15 | A |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|---|-----------------------------------|-------------|------|
| Power Dissipation @ T _A = 25°C (Note 4) | P_{D} | 1.3 | W |
| Thermal Resistance, Junction to Ambient Air (Note 4) @T _A = 25°C | $R_{	hetaJA}$ | 96.1 | °C/W |
| Power Dissipation @ T _A = 25°C (Note 5) | P_{D} | 3 | W |
| Thermal Resistance, Junction to Ambient Air (Note 5) @T _A = 25°C | $R_{	hetaJA}$ | 41.7 | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -55 to +150 | °C |

Notes:

Electrical Characteristics @TA = 25°C unless otherwise specified

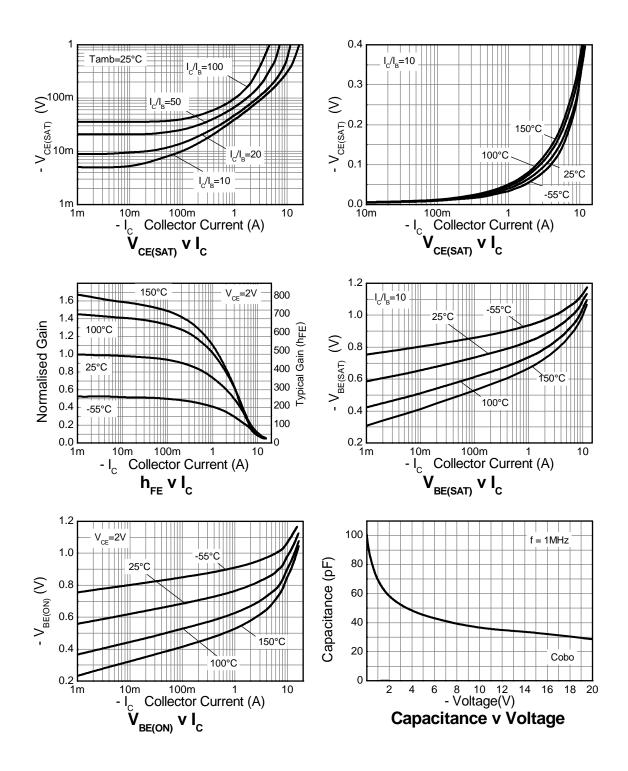
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|--|----------------------|-----------------------|----------------------------|-----------------------------|----------|--|
| Collector-Base Breakdown Voltage | V _{(BR)CBO} | -25 | -55 | | V | $I_C = -100 \mu A$ |
| Collector-Emitter Breakdown Voltage (Note 6) | $V_{(BR)CEO}$ | -20 | -50 | | V | $I_C = -10 \text{mA}$ |
| Emitter-Collector Breakdown Voltage (Reverse Blocking) | V _{(BR)ECX} | -4 | -8.6 | | > | I_E = -100μA, R_{BC} < 1k Ω or 0.25V > V_{CB} > -0.25V |
| Emitter-Base Breakdown Voltage (Reverse Blocking) | V _{(BR)ECO} | -4 | -8.6 | | ٧ | $I_E = -100 \mu A$ |
| Emitter-Base Breakdown Voltage | V _{(BR)EBO} | -7 | -8.2 | | ٧ | $I_E = -100 \mu A$ |
| Collector Cutoff Current | I _{CBO} | _ | <1 — | 50 0.5 | nA μA | V _{CB} = -25V V _{CB} = -25V, T _{amb} = 100 °C |
| Emitter Cutoff Current | I _{EBO} | _ | <1 | -50 | nA | V _{EB} = -5.6V |
| Collector-Emitter Saturation Voltage (Note 6) | V _{CE(sat)} | _ | -40 -97 -115 -220 | -47 -130 -145 -275 | mV | I _C = -1A, I _B = -100mA I _C = -1A, I _B = -10mA I _C = -2A, I _B = -40mA I _C = -8A, I _B = -800mA |
| Base-Emitter Saturation Voltage (Note 6) | V _{BE(sat)} | _ | -1050 | -1150 | mV | I _C = -8A, I _B = -800mA |
| Base-Emitter Turn-On Voltage (Note 6) | V _{BE(on)} | _ | -930 | -1000 | mV | $I_{C} = -8A, V_{CE} = -2V$ |
| DC Current Gain (Note 6) | h _{FE} | 300 200 45 — | 450 290 70 25 | 900 — — — | | I _C = -100mA, V _{CE} = -2V I _C = -2A, V _{CE} = -2V I _C = -8A, V _{CE} = -2V I _C = -15A, V _{CE} = -2V |
| Transition Frequency | f _T | _ | 176 | | MHz | $I_C = -50 \text{mA}, V_{CE} = -10 \text{V},$ f = 50MHz |
| Input Capacitance (Note 6) | C_{ibo} | _ | | 400 | pF | $V_{EB} = -0.5V, f = 1MHz$ |
| Output Capacitance (Note 6) | C_{obo} | | 36 | 45 | pF | $V_{CB} = -10V$, $f = 1MHz$ |
| Delay Time | t _d | _ | 23 | | | |
| Rise Time | t _r | | 18.4 | _ | ns | $I_C = -1A$, $V_{CC} = -10V$, |
| Storage Time | ts | _ | 266 | _ | 115 | $I_{B1} = -I_{B2} = -50 \text{mA}$ |
| Fall Time | t _f | _ | 49.6 | | | |

Notes: 6. Pulse Test: Pulse width ${\leq}300\mu s.$ Duty cycle ${\leq}2.0\%.$

^{4.} Device mounted on FR-4 PCB, 2 oz. copper, minimum recommended pad layout. 5. Device mounted on FR-4 PCB, 2 oz. copper, collector pad dimensions 0.42inch^2 .

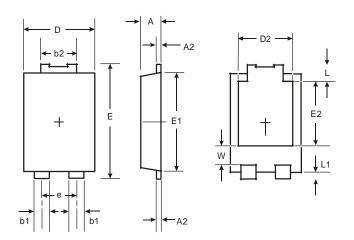


Typical Characteristic



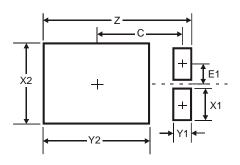


Package Outline Dimensions



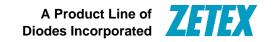
| PowerDI [®] 5 | | | | |
|------------------------|-----------|------|--|--|
| Dim | Min | Max | | |
| Α | 1.05 | 1.15 | | |
| A2 | 0.33 | 0.43 | | |
| b1 | 0.80 0.99 | | | |
| b2 | 1.70 1.8 | | | |
| D | 3.90 | 4.05 | | |
| D2 | 3.054 Typ | | | |
| Е | 6.40 6.6 | | | |
| е | 1.84 Typ | | | |
| E1 | 5.30 5.45 | | | |
| E2 | 3.549 Typ | | | |
| L | 0.75 0.9 | | | |
| L1 | 0.50 0.6 | | | |
| W | 1.10 | 1.41 | | |
| All Dimensions in mm | | | | |

Suggested Pad Layout



| Dimensions | Value (in mm) |
|------------|---------------|
| Z | 6.6 |
| X1 | 1.4 |
| X2 | 3.6 |
| Y1 | 0.8 |
| Y2 | 4.7 |
| С | 3.87 |
| F1 | 0.0 |





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